

Photocoupler

Product features

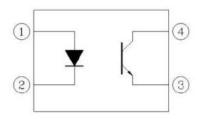
- Halogens free
 (Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm)</p>
- Current transfer ratio

(CTR: 50~600% at IF =5mA, VCE =5V) (CTR: 63~320% at IF =10mA, VCE =5V)

- High isolation voltage between inputs and output (Viso=5000 V rms)
- Compact 4 Pin SOP with a 2.1 mm profile
- Compliance with EU REACH
- Pb free and RoHS compliant



Schematic



PinConfiguration

- 1. Anode
- 2. Cathode
- 3. Emitter
- 4. Collector

Product Description

- EX101X series devices consist of an infrared emitting diode, optically coupled to a phototransistor detector encapsulated with compound.
- They are packaged in a 4-pin small outline SMD package.
- Compound use free halogens and Sb₂O₃.

Product Applications

- Measuring instruments
- System appliances
- Programmable controllers
- Home appliances
- Telecommunication equipments
- Signal transmission between circuits of different potentials and impedances

Ordering Information

Part Number	Package	Units/ Reel		
EX101X	LSOP4	3500		



Electrical-Optical characteristics

Absolute Maximum Ratings(Ta=25℃)

Parameter		Symbol	Rated Value	Unit
	Forward current	I _F	60	mA
Input	Peak forward current(1us pulse)	I _{FP}	1.5	Α
	Reverse voltage	V _R	6	V
	Power dissipation		100	mW
	Derating factor (above Ta=90°C)	P _D	-	mW/°C
Output	Power dissipation	Б	150	mW
	Derating factor (above Ta = 70°C)	P _c	_	mW/°C
	Collector current	Ic	50	mA
	Collector and emitter Voltage	V _{CEO}	80	V
	Emitter and Collector Voltage	V _{ECO}	7	V
Total Power Dissipation		P _{TOT}	250	mW
Isolation Voltage(1*)		V _{iso}	5000	Vrms
Operating temperature		T _{OPR}	-55 to +110	°C
Storage temperature		T _{STG}	-55 to +125	°C
Soldering temperature(1*)		T _{SOL}	260	℃

Notes

^{1*} AC for 1 minute, R.H.= $40 \sim 60\%$ R.H. In this test, pins 1, 2 are shorted together, and pins 3, 4 are shorted together.

^{2*} Soldering time is 10 seconds



Electro-Optical Characteristics(Ta=25°C unless specified otherwise)

Parameter		Symbol	Min.	Тур.	Max.	Unit	Condition
In put	Forward voltage	V _F	-	1.45	1.5	V	I _F =50mA
	Reverse current	I _R	-	-	10	μΑ	V _R =6V
	Input capacitance	Cin	-	50	-	pF	V=0,f=1kHz
Out put	Collector-Emitter dark current	I _{CEO}	-	-	100	nA	V _{CE} =20V I _F =0mA
	Collector-Emitter breakdown voltage	BV _{CEO}	80	-	-	V	Ic=0.1mA
	Emitter-Collector breakdown voltage	BV _{ECO}	7	-	-	V	I _E =0.1mA

Transfer Characteristics (Ta=25°C unless specified otherwise)

Parameter		Symbol	Min.	Тур.	Max.	Unit	Condition
	EX1010	CTR	50	-	600	%	I _F =5mA
	EX1017		80	-	160		
	EX1018		130	-	260		V _{CE} =5V
	EX1019		200	-	400		
Current	EX1012		63	-	125	- %	I _F =10mA V _{CE} =5V
Transferratio	EX1013		100	-	200		
	EX1014	CTR	160	-	320		
	EX1012		22	-	-		I _F =1mA V _{CE} =5V
	EX1013		34	-	-		
	EX1014		56	-	-		ACE-2A
Collector-Emitter saturation voltage		V _{CE(sat)}	-	-	0.3	V	I _F =10mA Ic=1mA
Isolation resistance		R _{IO}	5x10 ¹⁰	-	-	Ω	V _{IO} =500Vdc 40~60% RH.
Floating capacitance		C _{IO}	-	-	1.0	pF	V _{IO} =0,f=1MH z
Turn on time		Ton	-	4	-	μs	V _{CE} =5V, Ic=5mA,
Turn off time		Toff	-	3	-	μs	R _L =100Ω
Rise time		t _r	-	3	18	μs	V _{CE} =2V,
Fall time		t _f	-	4	18	μs	Ic=2mA, R _L =100



Characteristic Curves

Figure 1. Forward Current vs Forward
Voltage

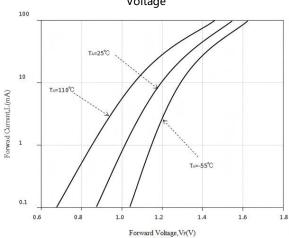


Figure 3. Normalized Current Transfer Ratio vs Forward Current

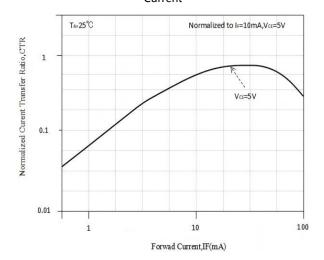


Figure 5. Collector Current vs Collector-Emitter Voltage

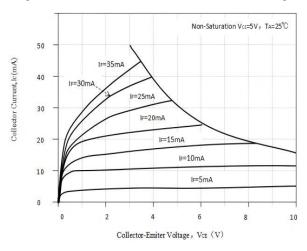


Figure 2. Normalized Collector Current vs
Forward Current

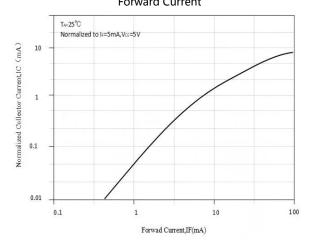


Figure 4. Dark Current vs Ambient Temperature

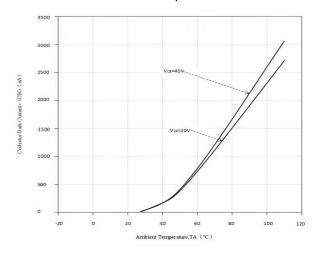


Figure 6. Collector Current vs Collector-Emitter Voltage

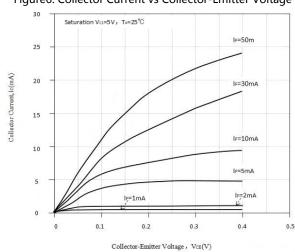




Figure 7. Normalized Curent Tansfer Ratio vs Ambient Tempernture

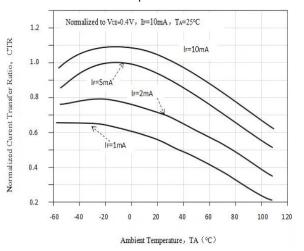


Figure 9. Tum on/off Time vs Collector Current

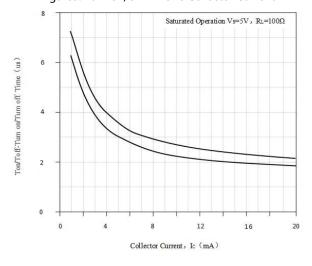


Figure 8. Normalized Curent Tansfer Ratio vs Ambient

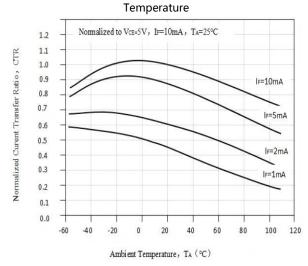


Figure 10. Tum on/off Time vs Forwad Current

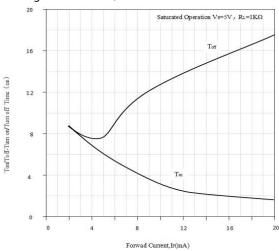
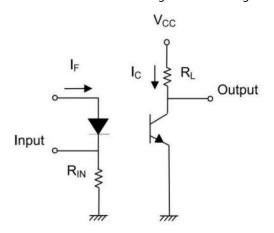
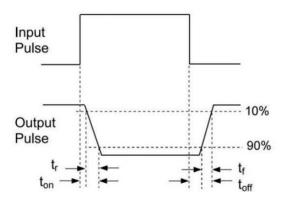


Figure 11. Switching Time Test Circuit vs Waveforms

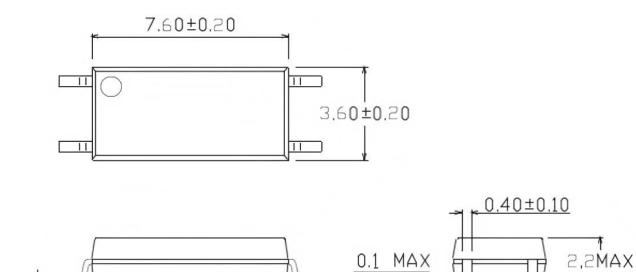






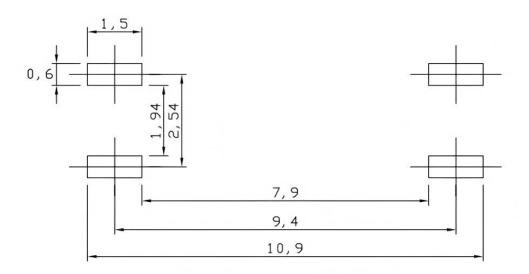
<u>0.25</u>

Package Drawing(Unit:mm)



Recommended pad layout for surface mount leadform

10.20±0.30



0.5MIN



Legal Disclaimer

The information given in this document shall be for illustrative purposes only and shall in no event be regarded as a guarantee of conditions or characteristics. Existar Technologies reserves the right to change any information herein. With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Existar Technologies or its affiliates hereby make no representation or warranty of any kind, expressed or implied, as to any information provided hereunder, including without limitation as to the accuracy, completeness or non-infringement of intellectual property rights of any third party, and they assume no liability for the consequences of use of such information. In addition, any information given in this document is subject to customer's compliance with its obligations stated herein and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Existar Technologies in customer's applications. The information contained herein is exclusively intended for technically trained staff. No license is granted by implication under any patent right, copyright, mask work right, or other intellectual property right. It is customer's sole responsibility to evaluate the suitability of the product for the intended application and the completeness of the product information given herein with respect to such application. In no event shall Existar Technologies or its affiliates be liable to any party for any direct, indirect, special, punitive, incidental or consequential damages of any nature whatsoever, including but not limited to loss of profits and loss of goodwill, whether or not such damages are based on tort or negligence, warranty, breach of contract or any other legal theory.